

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1	"6725529".pn.	USPAT; EPO; JPO	OR	ON	2004/08/26 16:00
S2	3	(overlay adj1 surface).ti. and (joel).in.	US-PGPUB; USPAT	OR	ON	2003/06/08 15:55
S3	13	(resistor).ti. and (joel).in.	US-PGPUB; USPAT	OR	ON	2003/06/08 15:57
S4	4	(resistor).ti. and (rainer).in.	US-PGPUB; USPAT	OR	ON	2003/06/08 15:57
S5	31	(resistor).ti. and strip and flat and overl\$5 and expos\$3	US-PGPUB; USPAT	OR	ON	2003/06/08 16:00
S6	10	("5104480" "5233327" "5569398" "5675310" "5685995" "5751585" "5753391" "5808272" "5849623" "5864430").PN.	USPAT	OR	ON	2003/06/08 16:52
S7	18	("3392440" "3779841" "4042479" "4063211" "4338145" "4434416" "4510178" "4563564" "4801469" "4987010" "5023589" "5189580" "5221639" "5227012" "5502885" "5683928" "5703630" "5874764").PN.	USPAT	OR	ON	2003/06/08 16:52
S8	297	29/610.1,611,612,613,614,619,620,621,627.ccls. and resist\$4 and conduct\$3 and strip	USPAT; EPO; JPO; DERWENT	OR	ON	2003/06/10 17:22
S9	43	(29/610.1,611,612,613,614,619,620,621,627.ccls. and resist\$4 and conduct\$3 and strip) and encapsulat\$3	USPAT; EPO; JPO; DERWENT	OR	ON	2003/06/10 17:15
S10	320	338/195,206,275,283,287,293,309,314,322,328,329.ccls. and resist\$4 and conduct\$3 and strip	USPAT; EPO; JPO; DERWENT	OR	ON	2003/06/10 17:19
S11	33	(338/195,206,275,283,287,293,309,314,322,328,329.ccls. and resist\$4 and conduct\$3 and strip) and encapsulat\$3	USPAT; EPO; JPO; DERWENT	OR	ON	2003/06/10 17:19
S12	208	"451"/\$.ccls. and resist\$4 and conduct\$3 and strip	USPAT; EPO; JPO; DERWENT	OR	ON	2003/06/10 17:23
S13	25	("451"/\$.ccls. and resist\$4 and conduct\$3 and strip) and encapsulat\$3	USPAT; EPO; JPO; DERWENT	OR	ON	2003/06/10 17:23
S14	763	resistor and conductive adj (layer film) and (etch\$3 remov\$3 expos\$3) and encapsulat\$3	USPAT; EPO; JPO	OR	ON	2003/10/28 11:53

S15	200	(resistor and conductive adj (layer film) and (etch\$3 remov\$3 expos\$3) and encapsulat\$3) and double	USPAT; EPO; JPO	OR	ON	2003/10/28 12:04
S16	66	(resistor and conductive adj (layer film) and (etch\$3 remov\$3 expos\$3) and encapsulat\$3) and double with (layer thick\$4)	USPAT; EPO; JPO	OR	ON	2003/10/28 12:16
S17	12	"5300188".URPN.	USPAT	OR	ON	2003/10/28 12:08
S18	17	("4643161" "4806900" "4863529" "4925701" "5002899" "5006914" "5066938" "5070040" "5071677" "5082359" "5086014" "5099296" "5127983" "5131963" "5136344" "5154023" "5246884").PN.	USPAT	OR	ON	2003/10/28 12:09
S19	952	conductive adj (strip layer film) with surface and (etch\$3 remov\$3 expos\$3 grind\$3 mill\$3 skiv\$3) and (cover\$3 overly\$3 super\$1impos\$3) and encapsulat\$4 and insulat\$4	USPAT; EPO; JPO	OR	ON	2003/10/28 12:19
S20	764	(conductive adj (strip layer film) with surface and (etch\$3 remov\$3 expos\$3 grind\$3 mill\$3 skiv\$3) and (cover\$3 overly\$3 super\$1impos\$3) and encapsulat\$4 and insulat\$4) and resist\$5	USPAT; EPO; JPO	OR	ON	2003/10/28 12:20
S21	702	((conductive adj (strip layer film) with surface and (etch\$3 remov\$3 expos\$3 grind\$3 mill\$3 skiv\$3) and (cover\$3 overly\$3 super\$1impos\$3) and encapsulat\$4 and insulat\$4) and resist\$5) and portion	USPAT; EPO; JPO	OR	ON	2003/10/28 12:21
S22	67	((((conductive adj (strip layer film) with surface and (etch\$3 remov\$3 expos\$3 grind\$3 mill\$3 skiv\$3) and (cover\$3 overly\$3 super\$1impos\$3) and encapsulat\$4 and insulat\$4) and resist\$5) and portion) and "29"/\$.ccls.	USPAT; EPO; JPO	OR	ON	2003/10/28 12:28
S23	7	"3566203".URPN.	USPAT	OR	ON	2003/10/28 12:27
S24	20	((((conductive adj (strip layer film) with surface and (etch\$3 remov\$3 expos\$3 grind\$3 mill\$3 skiv\$3) and (cover\$3 overly\$3 super\$1impos\$3) and encapsulat\$4 and insulat\$4) and resist\$5) and portion) and "338"/\$.ccls.	USPAT; EPO; JPO	OR	ON	2003/10/28 12:29

S25	1	((conductive adj (strip layer film) with surface and (etch\$3 remov\$3 expos\$3 grind\$3 mill\$3 skiv\$3) and (cover\$3 overly\$3 super\$1impos\$3) and encapsulat\$4 and insulat\$4) and resist\$5) and portion) and "451"/\$.ccls.	USPAT; EPO; JPO	OR	ON	2003/10/28 12:30
S26	19	((conductive adj (strip layer film) with surface and (etch\$3 remov\$3 expos\$3 grind\$3 mill\$3 skiv\$3) and (cover\$3 overly\$3 super\$1impos\$3) and encapsulat\$4 and insulat\$4) and resist\$5) and portion) and resist\$5.ti.	USPAT; EPO; JPO	OR	ON	2003/10/28 13:45
S27	0	29/601.1.ccls. and conductive adj (layer film strip)	USPAT; EPO; JPO	OR	ON	2003/10/28 13:45
S28	0	29/601.1.ccls. and conduct\$3 adj (layer film strip)	USPAT; EPO; JPO	OR	ON	2003/10/28 13:46
S29	4783	"29"/\$.ccls. and conduct\$3 adj (layer film strip)	USPAT; EPO; JPO	OR	ON	2003/10/28 13:46
S30	173	("29"/\$.ccls. and conduct\$3 adj (layer film strip)) and resist\$5.ti.	USPAT; EPO; JPO	OR	ON	2003/10/28 14:06
S31	29	("2662957" "3368919" "3489656" "3621442" "3742120" "3833410" "3849757" "3857683" "3864825" "4164607" "4203025" "4396900" "4482882" "4503112" "4517546" "4585537" "4617575" "4892776" "5038132" "5039570" "5128008" "5172473" "5243320" "5389446" "5661902" "5689227" "5709957" "5863666" "5908544").PN.	USPAT	OR	ON	2003/10/28 13:47
S32	343	(grind\$3 mill\$3 skiv\$3) and conduct\$3 adj (layer film strip) and resist\$5.ti.	USPAT; EPO; JPO	OR	ON	2003/10/28 14:08
S33	256	((grind\$3 mill\$3 skiv\$3) and conduct\$3 adj (layer film strip) and resist\$5.ti.) and insulat\$4	USPAT; EPO; JPO	OR	ON	2003/10/28 14:08
S34	181	((grind\$3 mill\$3 skiv\$3) and conduct\$3 adj (layer film strip) and resist\$5.ti.) and insulat\$4) and (encapsulat\$3 cover\$4)	USPAT; EPO; JPO	OR	ON	2003/10/28 16:29
S35	0	"4157284".URPN.	USPAT	OR	ON	2003/10/28 15:47
S36	0	"4157284".URPN.	USPAT	OR	ON	2003/10/28 15:47
S37	9	("4241103" "4685203" "5270493" "5347258" "5347712" "5603847" "5624258" "5716663" "5758413").PN.	USPAT	OR	ON	2003/10/28 15:54

S38	7	"4517546".URPN.	USPAT	OR	ON	2003/10/28 16:00
S39	6	("3849757" "4204187" "4220945" "4243969" "4342020" "4345236").PN.	USPAT	OR	ON	2003/10/28 16:01
S40	240	resistor.ti. and (grinding milling skiving)	USPAT; EPO; JPO	OR	ON	2003/10/28 16:30
S41	1	"6725529".pn.	USPAT; EPO; JPO	OR	ON	2005/02/03 17:10
S42	0	"20040168304"	USPAT; EPO; JPO	OR	ON	2005/02/03 17:10
S43	1	"20040168304"	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/02/03 17:10
S44	964	(resistive resistance) near3 (layer film plate strip) same (conductive metal\$4) near3 (layer film plate strip) and encapsulat\$3	USPAT; EPO; JPO	OR	ON	2005/02/03 18:39
S45	30	"338"/\$.ccls. and "29"/\$.ccls. and S44	USPAT; EPO; JPO	OR	ON	2005/02/03 18:05
S46	94	"338"/\$.ccls. and S44	USPAT; EPO; JPO	OR	ON	2005/02/03 18:08
S47	82	"29"/\$.ccls. and S44	USPAT; EPO; JPO	OR	ON	2005/02/03 18:09
S48	75	(resistive resistance) near3 (layer film plate strip sheet) with (conductive metal\$4) near3 (layer film plate strip sheet) same encapsulat\$3	USPAT; EPO; JPO	OR	ON	2005/02/03 18:41
S49	655	(resistive resistance) near3 (plate strip sheet) same (conductive metal\$4) near3 (plate strip sheet) same (cover\$3 protect\$3 encapsulat\$3)	USPAT; EPO; JPO	OR	ON	2005/02/03 18:42
S50	368	(resistive resistance) near2 (plate strip sheet) same (conductive metal\$4) near2 (plate strip sheet) same (cover\$3 protect\$3 encapsulat\$3)	USPAT; EPO; JPO	OR	ON	2005/02/03 18:47
S51	20	"29"/\$.ccls. and S50	USPAT; EPO; JPO	OR	ON	2005/02/03 18:43
S52	51	"338"/\$.ccls. and S50	USPAT; EPO; JPO	OR	ON	2005/02/03 18:44
S53	34	resist\$3.ti. and (resistive resistance) near2 (plate strip sheet) same (conductive metal\$4) near2 (plate strip sheet) same (cover\$3 protect\$3 encapsulat\$3)	USPAT; EPO; JPO	OR	ON	2005/02/03 18:47

S54	35	("0696757" "0765889" "0779737" "0859255" "1050563" "2003625" "2271995" "2708701" "2736785" "3018311" "3245021" "3778744" "4286249" "4450418" "4517546" "4591821" "4684916" "4689475" "4780702" "4800253" "4993142" "5604477" "6184775" "6322711").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/03 18:51
S55	27	("0696757" "0765889" "0779737" "0859255" "1050563" "2003625" "2271995" "2708701" "2736785" "3245021" "4286249" "4684916" "4689475" "4800253" "4993142" "5287083" "5604477").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/03 18:53